



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Teck Kheng Lee

Serial No.: 10/829,603

Filed: April 22, 2004

For: METHODS FOR ASSEMBLY AND
PACKAGING OF FLIP CHIP
CONFIGURED DICE WITH INTERPOSER

Confirmation No.: 6862

Examiner: S. Geyer

Group Art Unit: 2812

Attorney Docket No.: 2269-4974.2US
(00-0693.02/US)

Notice of Allowance Mailed:

February 7, 2006

NOTICE OF EXPRESS MAILING

Express Mail Mailing Label Number: EV 827473108 US

Date of Deposit with USPS: May 4, 2006

Person making Deposit: Timothy Palfreyman

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

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Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the specification begin on page 3 of this paper;

Amendments to the Abstract appear on page 19 of this paper;

OK TO
ENTER
HOK
5-11-06